

DWG. NO.

3X 120°

REV

3X R2.0 [R.08] CLEARANCE AROUND PIN

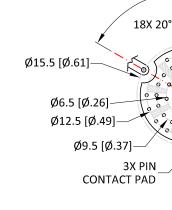
COPPER CLAD

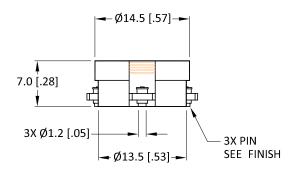
AREA

Ø.5 [Ø.02] Thru Via



3X 120°
(13.4 [.53])
RFCR 5401 (2X 3.9 [.15])
(Ø14.5 [Ø.57]) 7.7 [.31]
Ø18.5 [Ø.73]
$\emptyset$ 15.5 [ $\emptyset$ .61] $\longrightarrow \frac{1}{9}$ $\longrightarrow 3X$ 3.0 [.12]





# Recommended Footprint Copper-Solder Mask Pattern

SolderMask Pattern

The Land Pattern should be with good thermal conductivity

### Finish:

- 1. Housing: Silver plated
- 2. Pin: Gold plated
- 3. Coplanarity specification: 0.10 [.004] MAX.

## **Specifications**

Parameter	Minimum Typical		Maximum
Frequency Range (MHz)	1625		1680
Insertion Loss (dB)		< .25	.30
Isolation (dB)	20	> 23	
Return Loss (dB)	20	> 23	

## Power & Temperature Ratings

Parameter	Maximum	
Forward PWR Peak/AVG	500/100 Watts	
Reverse Power CW	80 Watts	
Operating Temperature	-40 to +85° C	
Storage Temperature	-50 to +125° C	

### NOTES:

- 1. Typical Values Represent Performance @ +23 °C.
- 2. S-Parameters to be measured by connecting Port 1 and 2 to VNA, and Port 3 to Load with return loss 30dB or higher

CW SMD CIRCULATOR MODEL: RFCR5401

THIRD ANGLE PROJECTION		DECL (A)				
APPROVALS	DATE					
DRAWN BY:						
CHECKED BY:		TITLE				
DESIGN BY:		OUTLINE/SPECS				
ENGINEER BY:		1 001111111/31 103				
MFG. ENGR.		SIZE CAGE NO DWG NO RE			IREV.	
Q.A.		Δ σ. τ.σ.		Briano.	Λ	
PROG. MGMT/MKT			CR540	·01-05	A	
		SCALE: FULL		SHEET 1 OF 1		
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